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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1500
Total RAM Bits	18432
Number of I/O	67
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec1e-4tn100c

Architecture Overview

The LatticeECP-DSP and LatticeEC architectures contain an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM Embedded Block RAM (EBR), as shown in Figures 2-1 and 2-2. In addition, LatticeECP-DSP supports an additional row of DSP blocks, as shown in Figure 2-2.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional unit without RAM/ROM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM, ROM and register functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row. The PFU blocks are used on the outside rows. The rest of the core consists of rows of PFF blocks interspersed with rows of PFU blocks. For every three rows of PFF blocks there is a row of PFU blocks.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. sysMEM EBRs are large dedicated fast memory blocks. They can be configured as RAM or ROM.

The PFU, PFF, PIC and EBR Blocks are arranged in a two-dimensional grid with rows and columns as shown in Figure 2-1. The blocks are connected with many vertical and horizontal routing channel resources. The place and route software tool automatically allocates these routing resources.

At the end of the rows containing the sysMEM Blocks are the sysCLOCK Phase Locked Loop (PLL) Blocks. These PLLs have multiply, divide and phase shifting capability; they are used to manage the phase relationship of the clocks. The LatticeECP/EC architecture provides up to four PLLs per device.

Every device in the family has a JTAG Port with internal Logic Analyzer (ispTRACY) capability. The sysCONFIG™ port which allows for serial or parallel device configuration. The LatticeECP/EC devices use 1.2V as their core voltage.

Figure 2-1. Simplified Block Diagram, LatticeEC Device (Top Level)

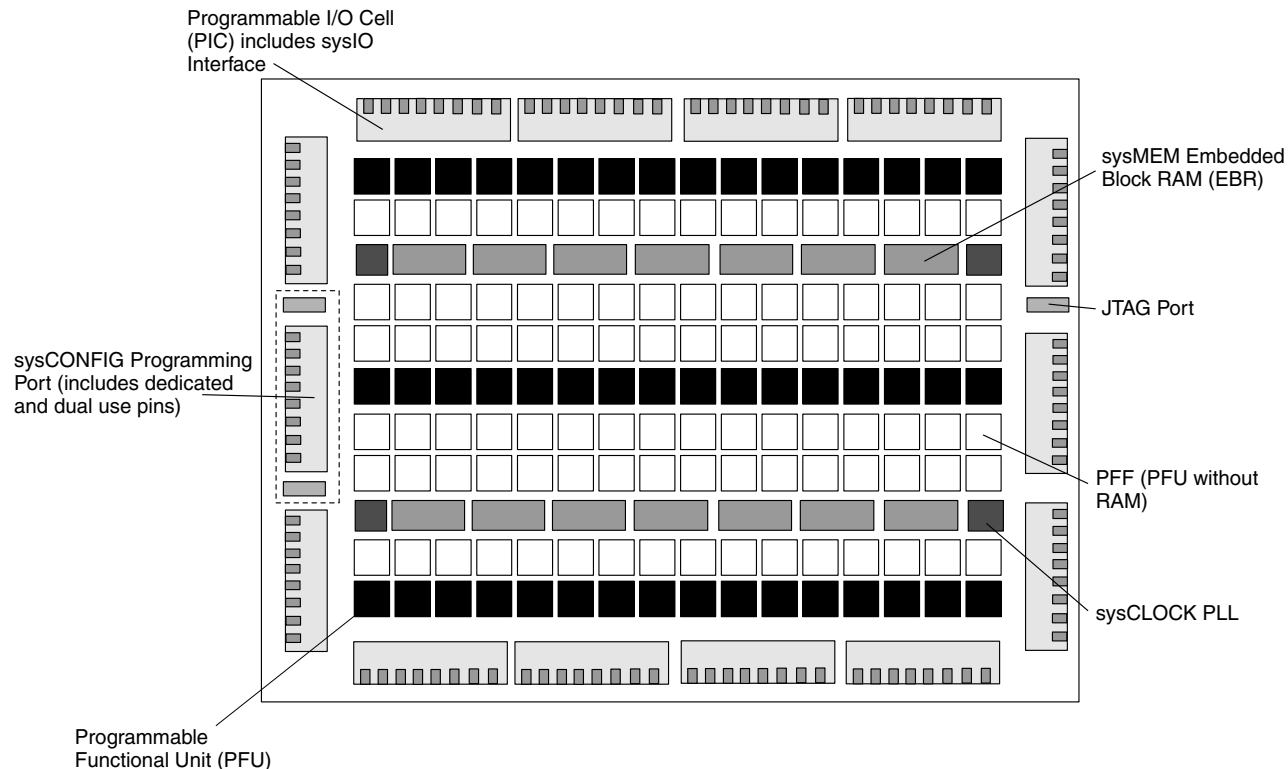


Figure 2-2. Simplified Block Diagram, LatticeECP-DSP Device (Top Level)

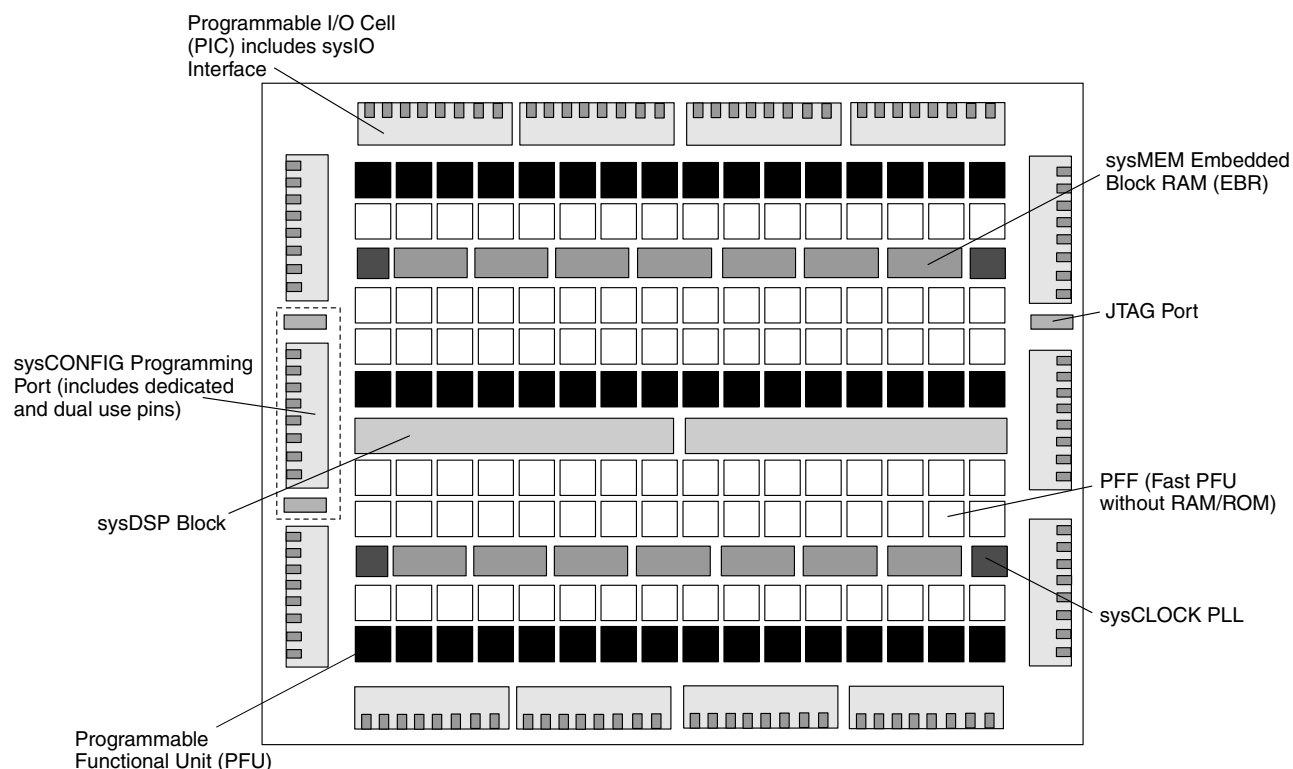


Figure 2-4. Slice Diagram

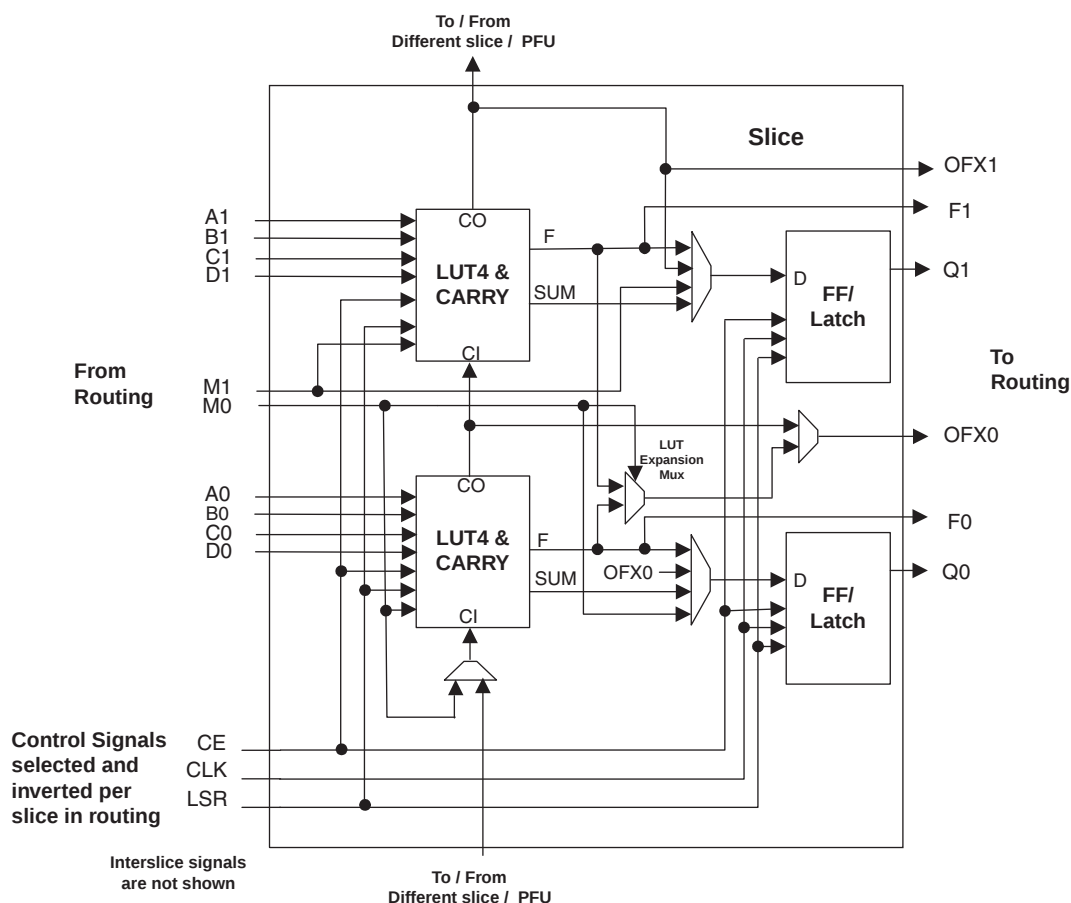


Table 2-1. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FCIN	Fast Carry In ¹
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register Outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8 ² MUX depending on the slice
Output	Inter-PFU signal	FCO	For the right most PFU the fast carry chain output ¹

1. See Figure 2-3 for connection details.

2. Requires two PFUs.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}^1	Input or I/O Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) \leq V_{IH} \leq 3.6V$	—	—	40	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-150	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	150	μA
I_{BHLS}	Bus Hold Low sustaining current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High sustaining current	$V_{IN} = 0.7V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	150	μA
I_{BHLH}	Bus Hold High Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	-150	μA
V_{BHT}	Bus Hold trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
C1	I/O Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf
C2	Dedicated Input Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. T_A 25°C, $f = 1.0MHz$

3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO} , a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO} .

Supply Current (Standby)^{1, 2, 3, 4}

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	LFEC1	6	mA
		LFEC3	10	mA
		LFEC6/LFEC6	15	mA
		LFEC10/LFEC10	25	mA
		LFEC15/LFEC15	35	mA
		LFEC20/LFEC20	60	mA
		LFEC33/LFEC33	85	mA
I_{CCAUX}	Auxiliary Power Supply Current		15	mA
I_{CCPLL}	PLL Power Supply Current		5	mA
I_{CCIO}	Bank Power Supply Current ⁶		2	mA
I_{CCJ}	V_{CCJ} Power Supply Current		5	mA

1. For further information about supply current, please see the list of technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a "blank" configuration data file.
5. $T_J=25^{\circ}\text{C}$, power supplies at nominal voltage.
6. Per bank.

BLVDS

The LatticeECP/EC devices support BLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

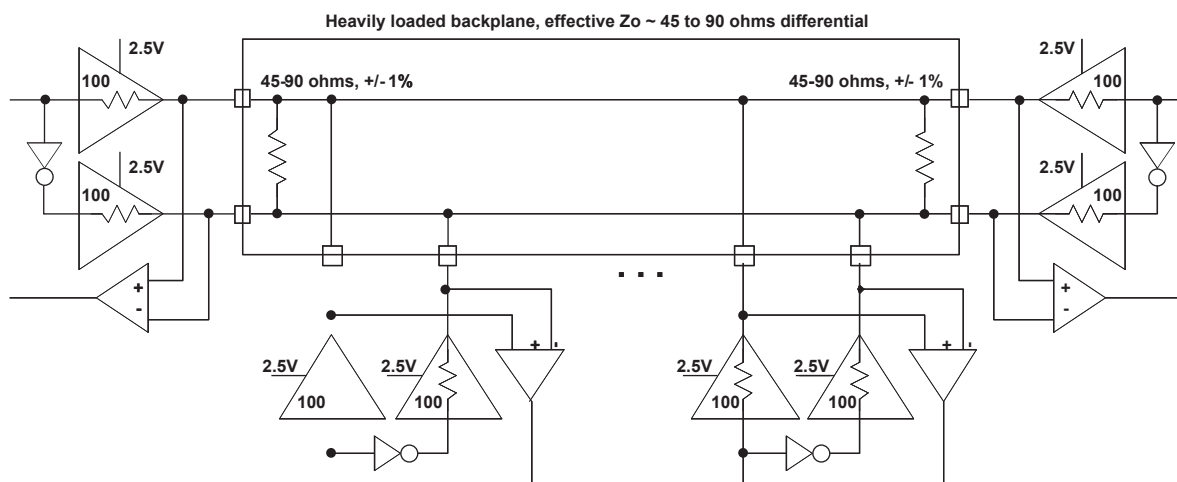


Table 3-2. BLVDS DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45	Zo = 90	
Z _{OUT}	Output impedance	100	100	ohm
R _{TLEFT}	Left end termination	45	90	ohm
R _{TRIGHT}	Right end termination	45	90	ohm
V _{OH}	Output high voltage	1.375	1.48	V
V _{OL}	Output low voltage	1.125	1.02	V
V _{OD}	Output differential voltage	0.25	0.46	V
V _{CM}	Output common mode voltage	1.25	1.25	V
I _{DC}	DC output current	11.2	10.2	mA

1. For input buffer, see LVDS table.

Derating Timing Tables

Logic Timing provided in the following sections of the data sheet and the ispLEVER design tools are worst-case numbers in the operating range. Actual delays at nominal temperature and voltage for best-case process, can be much better than the values given in the tables. To calculate logic timing numbers at a particular temperature and voltage multiply the noted numbers with the derating factors provided below.

The junction temperature for the FPGA depends on the power dissipation by the device, the package thermal characteristics (Θ_{JA}), and the ambient temperature, as calculated with the following equation:

$$T_{JMAX} = T_{AMAX} + (\text{Power} * \Theta_{JA})$$

The user must determine this temperature and then use it to determine the derating factor based on the following derating tables: T_J °C.

Table 3-5. Delay Derating Table for Internal Blocks

T_J °C Commercial	T_J °C Industrial	Power Supply Voltage		
		1.14V	1.2V	1.26V
—	-40	0.82	0.77	0.71
—	-25	0.82	0.76	0.71
0	20	0.89	0.83	0.78
25	45	0.93	0.87	0.81
85	105	1.00	0.94	0.89

LatticeECP/EC Internal Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description	-5		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
PFU/PFF Logic Mode Timing								
t _{LUT4_PFU}	LUT4 Delay (A to D Inputs to F Output)	—	0.25	—	0.31	—	0.36	ns
t _{LUT6_PFU}	LUT6 Delay (A to D Inputs to OFX Output)	—	0.40	—	0.48	—	0.56	ns
t _{LSR_PFU}	Set/Reset to Output of PFU	—	0.81	—	0.98	—	1.14	ns
t _{SUM_PFU}	Clock to Mux (M0,M1) Input Setup Time	0.12	—	0.14	—	0.16	—	ns
t _{HM_PFU}	Clock to Mux (M0,M1) Input Hold Time	-0.05	—	-0.06	—	-0.06	—	ns
t _{SUD_PFU}	Clock to D Input Setup Time	0.12	—	0.14	—	0.16	—	ns
t _{HD_PFU}	Clock to D Input Hold time	-0.03	—	-0.03	—	-0.04	—	ns
t _{CK2Q_PFU}	Clock to Q Delay, D-type Register Configuration	—	0.36	—	0.44	—	0.51	ns
t _{LE2Q_PFU}	Clock to Q Delay Latch Configuration	—	0.48	—	0.58	—	0.68	ns
t _{LD2Q_PFU}	D to Q Throughput Delay when Latch is Enabled	—	0.50	—	0.60	—	0.69	ns
PFU Dual Port Memory Mode Timing								
t _{CORAM_PFU}	Clock to Output	—	0.36	—	0.44	—	0.51	ns
t _{SUDATA_PFU}	Data Setup Time	-0.20	—	-0.24	—	-0.28	—	ns
t _{HDATA_PFU}	Data Hold Time	0.26	—	0.31	—	0.36	—	ns
t _{SUADDR_PFU}	Address Setup Time	-0.51	—	-0.62	—	-0.72	—	ns
t _{HADDR_PFU}	Address Hold Time	0.64	—	0.77	—	0.90	—	ns
t _{SUWREN_PFU}	Write/Read Enable Setup Time	-0.24	—	-0.29	—	-0.34	—	ns
t _{HWREN_PFU}	Write/Read Enable Hold Time	0.30	—	0.36	—	0.42	—	ns
PIC Timing								
PIO Input/Output Buffer Timing								
t _{IN_PIO}	Input Buffer Delay	—	0.56	—	0.67	—	0.78	ns
t _{OUT_PIO}	Output Buffer Delay	—	1.92	—	2.31	—	2.69	ns
IOLOGIC Input/Output Timing								
t _{SUI_PIO}	Input Register Setup Time (Data Before Clock)	0.90	—	1.08	—	1.26	—	ns
t _{HI_PIO}	Input Register Hold Time (Data after Clock)	0.62	—	0.74	—	0.87	—	ns
t _{COO_PIO}	Output Register Clock to Output Delay	—	0.33	—	0.40	—	0.46	ns
t _{SUCE_PIO}	Input Register Clock Enable Setup Time	-0.10	—	-0.12	—	-0.14	—	ns
t _{HCE_PIO}	Input Register Clock Enable Hold Time	0.12	—	0.14	—	0.17	—	ns
t _{SULSR_PIO}	Set/Reset Setup Time	0.18	—	0.21	—	0.25	—	ns
t _{HLSR_PIO}	Set/Reset Hold Time	-0.15	—	-0.18	—	-0.21	—	ns
EBR Timing								
t _{CO_EBR}	Clock to Output from Address or Data	—	3.64	—	4.37	—	5.10	ns
t _{COO_EBR}	Clock to Output from EBR output Register	—	0.74	—	0.88	—	1.03	ns
t _{SUDATA_EBR}	Setup Data to EBR Memory	-0.29	—	-0.35	—	-0.41	—	ns
t _{HDATA_EBR}	Hold Data to EBR Memory	0.37	—	0.44	—	0.52	—	ns
t _{SUADDR_EBR}	Setup Address to EBR Memory	-0.29	—	-0.35	—	-0.41	—	ns
t _{HADDR_EBR}	Hold Address to EBR Memory	0.37	—	0.45	—	0.52	—	ns
t _{SUWREN_EBR}	Setup Write/Read Enable to EBR Memory	-0.18	—	-0.22	—	-0.26	—	ns
t _{HWREN_EBR}	Hold Write/Read Enable to EBR Memory	0.23	—	0.28	—	0.33	—	ns

Timing Diagrams

PFU Timing Diagrams

Figure 3-6. Slice Single/Dual Port Write Cycle Timing

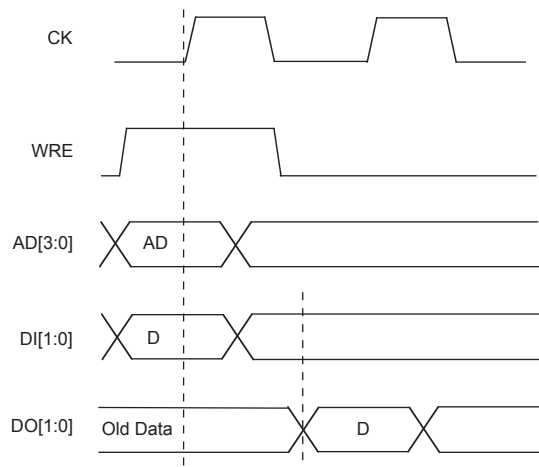


Figure 3-7. Slice Single /Dual Port Read Cycle Timing



sysCLOCK PLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		25	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)		25	—	420	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)		0.195	—	210	MHz
f_{VCO}	PLL VCO Frequency		420	—	840	MHz
f_{PFD}	Phase Detector Input Frequency		25	—	—	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default Duty Cycle Elected ³	45	50	55	%
t_{PH}^4	Output Phase Accuracy		—	—	0.05	UI
t_{OPJIT}^1	Output Clock Period Jitter	$f_{OUT} \geq 100\text{MHz}$	—	—	+/- 125	ps
		$f_{OUT} < 100\text{MHz}$	—	—	0.02	UIPP
t_{SK}	Input Clock to Output Clock Skew	Divider ratio = integer	—	—	+/- 200	ps
t_W	Output Clock Pulse Width	At 90% or 10% ³	1	—	—	ns
t_{LOCK}^2	PLL Lock-in Time		—	—	150	μs
t_{PA}	Programmable Delay Unit		100	250	450	ps
t_{IPJIT}	Input Clock Period Jitter		—	—	+/- 200	ps
t_{FBKDL}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width		10	—	—	ns

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock.

2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.

3. Using LVDS output buffers.

4. Relative to CLKOP.

Timing v.G 0.30



LatticeECP/EC Family Data Sheet

Pinout Information

September 2012

Data Sheet

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pin when not used as special purpose pins can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V _{CC}	—	Power supply pins for core logic. Dedicated pins.
V _{CCAUX}	—	Auxiliary power supply pin. It powers all the differential and referenced input buffers. Dedicated pins.
V _{CCIOx}	—	Power supply pins for I/O bank x. Dedicated pins.
V _{REF1_x} , V _{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins.
XRES	—	10K ohm +/-1% resistor must be connected between this pad and ground.
V _{CCPLL}	—	Power supply pin for PLL. Applicable to ECP/EC33 device.
PLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_PLL[T, C]_IN_A	I	Reference clock (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_PLL[T, C]_FB_A	I	Optional feedback (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.
[LOC]DQS[num]	I	DQS input pads: T (Top), R (Right), B (Bottom), L (Left), DQS, num = ball function number. Any pad can be configured to be output.
Test and Programming (Dedicated pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.

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Power Supply and NC Connections

Signals	100 TQFP	144 TQFP	208 PQFP	256 fpBGA
VCC	12, 64	EC1, EC3: 13, 92, 99 ECP/EC6: 11, 13, 92, 99	EC1, EC3: 26, 128, 135 ECP/EC6: 24, 26, 128, 135 ECP/EC10: 5, 24, 26, 128, 135, 152	E12, E5, E8, M12, M5, M9, F6, F11, L11, L6
VCCIO0	100	136, 143	EC1: 187, 208 EC3, ECP/EC6, ECP/EC10: 187, 197, 208	F7, F8
VCCIO1	86	110, 125	157, 176	F9, F10
VCCIO2	73	108	EC1: 155 EC3, ECP/EC6, ECP/EC10: 145, 155	G11, H11
VCCIO3	56	73, 84	106, 120	J11, K11
VCCIO4	38	55, 71	85, 104	L9, L10
VCCIO5	26	38, 44	EC1: 53, 74 EC2, ECP/EC6, ECP/EC10: 53, 64, 74	L7, L8
VCCIO6	24	24, 36	37, 51	J6, K6
VCCIO7	2	1	EC1: 2 EC3, ECP/EC6, ECP/EC10: 2, 13	G6, H6
VCCJ	18	19	32	L4
VCCAUX	37, 87	54, 126	EC1: 84, 177 EC3, ECP/EC6, ECP/EC10: 22, 84, 136, 177	B15, R2
VCCPLL	—	—	—	—
GND, GND0-GND7	1, 14, 25, 35, 51, 68, 74, 89	EC1, EC3: 15, 28, 37, 52, 63, 72, 80, 96, 98, 109, 117, 128, 144 ECP/EC6: 12, 15, 28, 37, 52, 63, 72, 80, 96, 98, 109, 117, 128, 144	EC1: 1, 28, 41, 52, 82, 93, 105, 116, 132, 134, 156, 168, 179 EC3: 1, 28, 41, 52, 72, 82, 93, 105, 116, 132, 134, 138, 156, 168, 179, 189 ECP/EC6: 1, 18, 25, 28, 41, 52, 72, 82, 93, 105, 116, 132, 134, 138, 156, 168, 179, 189 ECP/EC10: 1, 6, 18, 25, 28, 41, 52, 72, 82, 93, 105, 116, 132, 134, 138, 151, 156, 168, 179, 189	A1, A16, G10, G7, G8, G9, H10, H7, H8, H9, J10, J7, J8, J9, K10, K7, K8, K9, T1, T16
NC	—	EC1, EC3: 11, 12 ECP6/EC6: None	EC1: 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 18, 22, 24, 25, 54, 55, 56, 57, 58, 59, 60, 61, 62, 63, 64, 72, 103, 136, 138, 144, 145, 146, 147, 148, 149, 150, 151, 152, 158, 189, 197, 198, 199, 200, 201, 202, 203, 204, 205, 206, 207 EC3: 5, 6, 18, 24, 25, 103, 151, 152, 158 ECP/EC6: 5, 6, 151, 152 ECP/EC10: None	EC3: G5, H5, F2, F1, H4, H3, G2, G1, J4, J3, J5, K5, H2, H1, J2, J1, R12, H16, H15, G16, G15, K12, J12, J14, J15, F16, F15, J13, H13, H14, G14, E16, E15, B13, C13 ECP/EC10: None ECP/EC15: None

LFEC6P/EC6, LFEC6P/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6P/EC6				LFEC6P/EC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
127	CFG0	3			CFG0	3		
128	VCC	-			VCC	-		
129	PROGRAMN	3			PROGRAMN	3		
130	CCLK	3			CCLK	3		
131	INITN	3			INITN	3		
132	GND	-			GND	-		
133	DONE	3			DONE	3		
134	GND	-			GND	-		
135	VCC	-			VCC	-		
136	VCCAUX	-			VCCAUX	-		
137	PR9B	2	C	PCLKC2_0	PR18B	2	C	PCLKC2_0
138	GND2	2			GND2	2		
139	PR9A	2	T	PCLKT2_0	PR18A	2	T	PCLKT2_0
140	PR8B	2	C		PR17B	2	C	
141	PR8A	2	T		PR17A	2	T	
142	PR7B	2	C		PR16B	2	C	
143	PR7A	2	T		PR16A	2	T	
144	PR6B	2	C		PR15B	2	C	
145	VCCIO2	2			VCCIO2	2		
146	PR6A	2	T	RDQS6	PR15A	2	T	RDQS15
147	PR5B	2	C		PR14B	2	C	
148	PR5A	2	T		PR14A	2	T	
149	PR4B	2	C		PR13B	2	C	
150	PR4A	2	T		PR13A	2	T	
151	NC	-			GND	-		
152	NC	-			VCC	-		
153	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
154	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
155	VCCIO2	2			VCCIO2	2		
156*	GND1 GND2	-			GND1 GND2	-		
157	VCCIO1	1			VCCIO1	1		
158	PT33A	1			PT41A	1		
159	PT25B	1	C		PT33B	1	C	
160	PT25A	1	T		PT33A	1	T	
161	PT24B	1	C		PT32B	1	C	
162	PT24A	1	T		PT32A	1	T	
163	PT23B	1	C		PT31B	1	C	
164	PT23A	1	T		PT31A	1	T	
165	PT22B	1	C		PT30B	1	C	
166	PT22A	1	T	TDQS22	PT30A	1	T	TDQS30
167	PT21B	1	C		PT29B	1	C	
168	GND1	1			GND1	1		

LFEC6/EC6, LFEC6/EC10, LFEC6/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6/LFEC6					LFEC10/LFEC10					LFEC6/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND5	5			GND	GND5	5			GND	GND5	5		
V7	NC	-			V7	PB2A	5	T		V7	PB2A	5	T	
T6	NC	-			T6	PB2B	5	C		T6	PB2B	5	C	
V8	NC	-			V8	PB3A	5	T		V8	PB3A	5	T	
U7	NC	-			U7	PB3B	5	C		U7	PB3B	5	C	
W5	NC	-			W5	PB4A	5	T		W5	PB4A	5	T	
U6	NC	-			U6	PB4B	5	C		U6	PB4B	5	C	
AA3	NC	-			AA3	PB5A	5	T		AA3	PB5A	5	T	
AB3	NC	-			AB3	PB5B	5	C		AB3	PB5B	5	C	
Y6	NC	-			Y6	PB6A	5	T	BDQS6	Y6	PB6A	5	T	BDQS6
V6	NC	-			V6	PB6B	5	C		V6	PB6B	5	C	
AA5	NC	-			AA5	PB7A	5	T		AA5	PB7A	5	T	
W6	NC	-			W6	PB7B	5	C		W6	PB7B	5	C	
Y5	NC	-			Y5	PB8A	5	T		Y5	PB8A	5	T	
Y4	NC	-			Y4	PB8B	5	C		Y4	PB8B	5	C	
AA4	NC	-			AA4	PB9A	5	T		AA4	PB9A	5	T	
GND	-	-			GND	GND5	5			GND	GND5	5		
AB4	NC	-			AB4	PB9B	5	C		AB4	PB9B	5	C	
Y7	PB2A	5	T		Y7	PB10A	5	T		Y7	PB10A	5	T	
W8	PB2B	5	C		W8	PB10B	5	C		W8	PB10B	5	C	
W7	PB3A	5	T		W7	PB11A	5	T		W7	PB11A	5	T	
U8	PB3B	5	C		U8	PB11B	5	C		U8	PB11B	5	C	
W9	PB4A	5	T		W9	PB12A	5	T		W9	PB12A	5	T	
U9	PB4B	5	C		U9	PB12B	5	C		U9	PB12B	5	C	
Y8	PB5A	5	T		Y8	PB13A	5	T		Y8	PB13A	5	T	
GND	-	-			GND	GND5	5			GND	GND5	5		
Y9	PB5B	5	C		Y9	PB13B	5	C		Y9	PB13B	5	C	
V9	PB6A	5	T	BDQS6	V9	PB14A	5	T	BDQS14	V9	PB14A	5	T	BDQS14
T9	PB6B	5	C		T9	PB14B	5	C		T9	PB14B	5	C	
W10	PB7A	5	T		W10	PB15A	5	T		W10	PB15A	5	T	
U10	PB7B	5	C		U10	PB15B	5	C		U10	PB15B	5	C	
V10	PB8A	5	T		V10	PB16A	5	T		V10	PB16A	5	T	
T10	PB8B	5	C		T10	PB16B	5	C		T10	PB16B	5	C	
AA6	PB9A	5	T		AA6	PB17A	5	T		AA6	PB17A	5	T	
GND	GND5	5			GND	GND5	5			GND	GND5	5		
AB5	PB9B	5	C		AB5	PB17B	5	C		AB5	PB17B	5	C	
AA8	PB10A	5	T		AA8	PB18A	5	T		AA8	PB18A	5	T	
AA7	PB10B	5	C		AA7	PB18B	5	C		AA7	PB18B	5	C	
AB6	PB11A	5	T		AB6	PB19A	5	T		AB6	PB19A	5	T	
AB7	PB11B	5	C		AB7	PB19B	5	C		AB7	PB19B	5	C	
Y10	PB12A	5	T		Y10	PB20A	5	T		Y10	PB20A	5	T	
W11	PB12B	5	C		W11	PB20B	5	C		W11	PB20B	5	C	
AB8	PB13A	5	T		AB8	PB21A	5	T		AB8	PB21A	5	T	
GND	GND5	5			GND	GND5	5			GND	GND5	5		
AB9	PB13B	5	C		AB9	PB21B	5	C		AB9	PB21B	5	C	
AA10	PB14A	5	T	BDQS14	AA10	PB22A	5	T	BDQS22	AA10	PB22A	5	T	BDQS22
AA9	PB14B	5	C		AA9	PB22B	5	C		AA9	PB22B	5	C	
Y11	PB15A	5	T		Y11	PB23A	5	T		Y11	PB23A	5	T	
AA11	PB15B	5	C		AA11	PB23B	5	C		AA11	PB23B	5	C	
V11	PB16A	5	T	VREF2_5	V11	PB24A	5	T	VREF2_5	V11	PB24A	5	T	VREF2_5

LFEC6/EC6, LFEC6/EC10, LFEC6/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6/LFEC6					LFEC10/LFEC10					LFEC15/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
T11	VCCIO5	5			T11	VCCIO5	5			T11	VCCIO5	5		
M7	VCCIO6	6			M7	VCCIO6	6			M7	VCCIO6	6		
M8	VCCIO6	6			M8	VCCIO6	6			M8	VCCIO6	6		
N8	VCCIO6	6			N8	VCCIO6	6			N8	VCCIO6	6		
P8	VCCIO6	6			P8	VCCIO6	6			P8	VCCIO6	6		
J8	VCCIO7	7			J8	VCCIO7	7			J8	VCCIO7	7		
K8	VCCIO7	7			K8	VCCIO7	7			K8	VCCIO7	7		
L7	VCCIO7	7			L7	VCCIO7	7			L7	VCCIO7	7		
L8	VCCIO7	7			L8	VCCIO7	7			L8	VCCIO7	7		
G15	VCCAUX	-			G15	VCCAUX	-			G15	VCCAUX	-		
G16	VCCAUX	-			G16	VCCAUX	-			G16	VCCAUX	-		
G7	VCCAUX	-			G7	VCCAUX	-			G7	VCCAUX	-		
G8	VCCAUX	-			G8	VCCAUX	-			G8	VCCAUX	-		
H16	VCCAUX	-			H16	VCCAUX	-			H16	VCCAUX	-		
H7	VCCAUX	-			H7	VCCAUX	-			H7	VCCAUX	-		
R16	VCCAUX	-			R16	VCCAUX	-			R16	VCCAUX	-		
R7	VCCAUX	-			R7	VCCAUX	-			R7	VCCAUX	-		
T15	VCCAUX	-			T15	VCCAUX	-			T15	VCCAUX	-		
T16	VCCAUX	-			T16	VCCAUX	-			T16	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-			T8	VCCAUX	-		
J6	VCC	-			J6	VCC	-			J6	VCC	-		
J17	VCC	-			J17	VCC	-			J17	VCC	-		
P6	VCC	-			P6	VCC	-			P6	VCC	-		
P17	VCC	-			P17	VCC	-			P17	VCC	-		
A2	NC	-			A2	NC	-			A2	NC	-		
AB2	NC	-			AB2	NC	-			AB2	NC	-		
A21	NC	-			A21	NC	-			A21	NC	-		

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
W20	PR48B	3	C	VREF2_3	W20	PR68B	3	C	VREF2_3
Y20	PR48A	3	T	VREF1_3	Y20	PR68A	3	T	VREF1_3
GND	-	-			GND	GND3	3		
GND	-	-			GND	GND3	3		
AA21	PR47B	3	C		AA21	PR59B	3	C	
AB21	PR47A	3	T		AB21	PR59A	3	T	
W19	PR46B	3	C		W19	PR58B	3	C	
V19	PR46A	3	T		V19	PR58A	3	T	
Y21	PR45B	3	C		Y21	PR57B	3	C	
AA22	PR45A	3	T	RDQS45	AA22	PR57A	3	T	RDQS57
V20	PR44B	3	C	RLM0_PLLC_IN_A	V20	PR56B	3	C	RLM0_PLLC_IN_A
GND	GND3	3			GND	GND3	3		
U20	PR44A	3	T	RLM0_PLLT_IN_A	U20	PR56A	3	T	RLM0_PLLT_IN_A
W21	PR43B	3	C	RLM0_PLLC_FB_A	W21	PR55B	3	C	RLM0_PLLC_FB_A
Y22	PR43A	3	T	RLM0_PLLT_FB_A	Y22	PR55A	3	T	RLM0_PLLT_FB_A
V21	PR42B	3	C	DI/CSSPIN	V21	PR54B	3	C	DI/CSSPIN
W22	PR42A	3	T	DOUT/CSON	W22	PR54A	3	T	DOUT/CSON
U21	PR41B	3	C	BUSY/SISPI	U21	PR53B	3	C	BUSY/SISPI
V22	PR41A	3	T	D7/SPID0	V22	PR53A	3	T	D7/SPID0
T19	CFG2	3			T19	CFG2	3		
U19	CFG1	3			U19	CFG1	3		
U18	CFG0	3			U18	CFG0	3		
V18	PROGRAMN	3			V18	PROGRAMN	3		
T20	CCLK	3			T20	CCLK	3		
T21	INITN	3			T21	INITN	3		
R20	DONE	3			R20	DONE	3		
GND	GND3	3			GND	GND3	3		
T18	PR37B	3	C		T18	PR49B	3	C	
R17	PR37A	3	T		R17	PR49A	3	T	
R19	PR36B	3	C		R19	PR48B	3	C	
R18	PR36A	3	T	RDQS36	R18	PR48A	3	T	RDQS48
U22	PR35B	3	C		U22	PR47B	3	C	
GND	GND3	3			GND	GND3	3		
T22	PR35A	3	T		T22	PR47A	3	T	
R21	PR34B	3	C		R21	PR46B	3	C	
R22	PR34A	3	T		R22	PR46A	3	T	
P20	PR33B	3	C		P20	PR45B	3	C	
N20	PR33A	3	T		N20	PR45A	3	T	
P19	PR32B	3	C		P19	PR44B	3	C	
P18	PR32A	3	T		P18	PR44A	3	T	
P21	PR31B	3	C		P21	PR43B	3	C	
GND	GND3	3			GND	GND3	3		
P22	PR31A	3	T		P22	PR43A	3	T	
N21	PR30B	3	C		N21	PR42B	3	C	

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
N22	PR30A	3	T		N22	PR42A	3	T	
N19	PR29B	3	C		N19	PR41B	3	C	
N18	PR29A	3	T		N18	PR41A	3	T	
M21	PR28B	3	C		M21	PR40B	3	C	
L20	PR28A	3	T	RDQS28	L20	PR40A	3	T	RDQS40
L21	PR27B	3	C		L21	PR39B	3	C	
GND	GND3	3			GND	GND3	3		
M20	PR27A	3	T		M20	PR39A	3	T	
M18	PR26B	3	C		M18	PR38B	3	C	
M19	PR26A	3	T		M19	PR38A	3	T	
M22	PR25B	3	C		M22	PR37B	3	C	
L22	PR25A	3	T		L22	PR37A	3	T	
K22	PR24B	3	C		K22	PR36B	3	C	
K21	PR24A	3	T		K21	PR36A	3	T	
J22	PR22B	2	C	PCLKC2_0	J22	PR34B	2	C	PCLKC2_0
GND	GND2	2			GND	GND2	2		
J21	PR22A	2	T	PCLKT2_0	J21	PR34A	2	T	PCLKT2_0
H22	PR21B	2	C		H22	PR33B	2	C	
H21	PR21A	2	T		H21	PR33A	2	T	
L19	PR20B	2	C		L19	PR32B	2	C	
L18	PR20A	2	T		L18	PR32A	2	T	
K20	PR19B	2	C		K20	PR31B	2	C	
J20	PR19A	2	T	RDQS19	J20	PR31A	2	T	RDQS31
K19	PR18B	2	C		K19	PR30B	2	C	
GND	GND2	2			GND	GND2	2		
K18	PR18A	2	T		K18	PR30A	2	T	
G22	PR17B	2	C		G22	PR29B	2	C	
F22	PR17A	2	T		F22	PR29A	2	T	
F21	PR16B	2	C		F21	PR28B	2	C	
E22	PR16A	2	T		E22	PR28A	2	T	
E21	PR15B	2	C		E21	PR27B	2	C	
D22	PR15A	2	T		D22	PR27A	2	T	
G21	PR14B	2	C		G21	PR26B	2	C	
G20	PR14A	2	T		G20	PR26A	2	T	
GND	GND2	2			GND	GND2	2		
J18	PR13B	2	C		J18	PR25B	2	C	
H19	PR13A	2	T		H19	PR25A	2	T	
J19	PR12B	2	C		J19	PR24B	2	C	
H20	PR12A	2	T		H20	PR24A	2	T	
H17	PR11B	2	C		H17	PR23B	2	C	
H18	PR11A	2	T		H18	PR23A	2	T	RDQS23
D21	PR9B	2	C	RUM0_PLLC_FB_A	D21	PR17B	2	C	RUM0_PLLC_FB_A
GND	GND2	2			GND	GND2	2		
GND	-	-			GND	GND2	2		

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
A17	PT47A	1	T		A17	PT47A	1	T	
B15	PT46B	1	C		B15	PT46B	1	C	
A16	PT46A	1	T	TDQS46	A16	PT46A	1	T	TDQS46
A15	PT45B	1	C		A15	PT45B	1	C	
GND	GND1	1			GND	GND1	1		
A14	PT45A	1	T		A14	PT45A	1	T	
G14	PT44B	1	C		G14	PT44B	1	C	
E15	PT44A	1	T		E15	PT44A	1	T	
D15	PT43B	1	C		D15	PT43B	1	C	
C15	PT43A	1	T		C15	PT43A	1	T	
C14	PT42B	1	C		C14	PT42B	1	C	
B14	PT42A	1	T		B14	PT42A	1	T	
A13	PT41B	1	C		A13	PT41B	1	C	
GND	GND1	1			GND	GND1	1		
B13	PT41A	1	T		B13	PT41A	1	T	
E14	PT40B	1	C		E14	PT40B	1	C	
C13	PT40A	1	T		C13	PT40A	1	T	
F14	PT39B	1	C		F14	PT39B	1	C	
D14	PT39A	1	T		D14	PT39A	1	T	
E13	PT38B	1	C		E13	PT38B	1	C	
G13	PT38A	1	T	TDQS38	G13	PT38A	1	T	TDQS38
A12	PT37B	1	C		A12	PT37B	1	C	
GND	GND1	1			GND	GND1	1		
B12	PT37A	1	T		B12	PT37A	1	T	
F13	PT36B	1	C		F13	PT36B	1	C	
D13	PT36A	1	T		D13	PT36A	1	T	
F12	PT35B	1	C	VREF2_1	F12	PT35B	1	C	VREF2_1
D12	PT35A	1	T	VREF1_1	D12	PT35A	1	T	VREF1_1
F11	PT34B	1	C		F11	PT34B	1	C	
C12	PT34A	1	T		C12	PT34A	1	T	
A11	PT33B	0	C	PCLKC0_0	A11	PT33B	0	C	PCLKC0_0
GND	GND0	0			GND	GND0	0		
A10	PT33A	0	T	PCLKT0_0	A10	PT33A	0	T	PCLKT0_0
E12	PT32B	0	C	VREF1_0	E12	PT32B	0	C	VREF1_0
E11	PT32A	0	T	VREF2_0	E11	PT32A	0	T	VREF2_0
B11	PT31B	0	C		B11	PT31B	0	C	
C11	PT31A	0	T		C11	PT31A	0	T	
B9	PT30B	0	C		B9	PT30B	0	C	
B10	PT30A	0	T	TDQS30	B10	PT30A	0	T	TDQS30
A9	PT29B	0	C		A9	PT29B	0	C	
GND	GND0	0			GND	GND0	0		
A8	PT29A	0	T		A8	PT29A	0	T	
D11	PT28B	0	C		D11	PT28B	0	C	
C10	PT28A	0	T		C10	PT28A	0	T	

Thermal Management

Thermal management is recommended as part of any sound FPGA design methodology. To assess the thermal characteristics of a system, Lattice specifies a maximum allowable junction temperature in all device data sheets. Designers must complete a thermal analysis of their specific design to ensure that the device and package do not exceed the junction temperature limits. Refer to the Thermal Management document to find the device/package specific thermal values.

For Further Information

For further information regarding Thermal Management, refer to the following located on the Lattice website at www.latticesemi.com.

- Thermal Management document
- Technical Note TN1052 - Power Estimation and Management for LatticeECP/EC and LatticeXP Devices
- Power Calculator tool included with Lattice's ispLEVER design tool, or as a standalone download from www.latticesemi.com/software



LatticeECP/EC Family Data Sheet

Revision History

September 2012

Data Sheet DS1000

Revision History

Date	Version	Section	Change Summary
June 2004	01.0	—	Initial release.
August 2004	01.1	Introduction	Added new device LFECP/LFEC33 in Table 1-1.
		Architecture	Added New device LFECP/LFEC33 in Tables 2-9, 2-10 and 2-11.
		DC & Switching Characteristics	Added New device LFECP/LFEC33 on Supply current (Standby) tables. Added New device LFECP/LFEC33 on Initialization Supply current tables.
		Ordering Information	Added 33K Logic Capacity Device in Part Number Description section. Added EC33, ECP33 device: Industrial and Commercial to Part Number table. Corrected I/O counts in the part number tables for 100/144 TQFP and 208 PQFP packages to match Table 1-1 on page 1.
November 2004	01.3	Introduction	Changed DDR333 (166MHz) to DDR400 (200MHz)
			Added “RSDS” offering to the Features list: Flexible I/O Buffer
		Architecture	Added information about Secondary Clock Sources
			Added information about DCS
			Added a section on “Recommended Power-up Sequence”
			Updated Figure 2-24 “DQS Routing”
			Added DSP Block performance numbers to Table 2-11
			Added another row for RSDS in Table 2-13 and Table 2-14
		DC & Switching Characteristics	Updated new timing numbers
			Added numbers to derating table
			Added DC conditions to RSDS table
			Changed LVDS Max. V_{CCIO} to 2.625
			Added a row for RSDS in “Operating Condition” table
			Updated standby and initialization current table
			Added figure 3-12: sysConfig SPI port sequence
			Added DDR Timing Table and DDR Timings Figure 3-6
		Pinout Information	Added LFECP/EC6 to Pin Information
			Added LFECP/EC6 to Power Supply and NC Connections
			Added LFECP/EC6 144 TQFP Logic Signal Connections
			Added LFECP/EC6 208 PQFP Logic Signal Connections
			Added LFECP/EC6 256 fpBGA Logic Signal Connections
			Added LFECP/EC6 484 fpBGA Logic Signal Connections
		Ordering Information	Added 33K Logic Capacity Device in Part Number Description section.
			Added Part Number table for Commercial EC33.
			Added Part Number table for Commercial ECP33.
			Added Part Number table for Industrial EC33.
			Added Part Number table for Industrial ECP33.